

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.	:	10/743,105
Applicant	:	Christoph Nolscher
Confirmation No.	:	8012
Filed	:	December 23, 2003
TC/A.U.	:	1756
Examiner	:	Chacko Davis, Deborah
Customer No.	:	54500
Docket No.	:	3000.0016C
Title	:	Method for Forming a Structure Element on a Wafer by Means of a Mask and a Trimming Mask Assigned Hereto

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT**

Sir:

In response to the Office Action mailed January 17, 2007, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims, which begins on page 2 of this paper.

**Remarks** begin on page 5 of this paper.